Developing a New Generation of Integrated μ-Spec Far-Infrared Spectrometers for EXCLAIM

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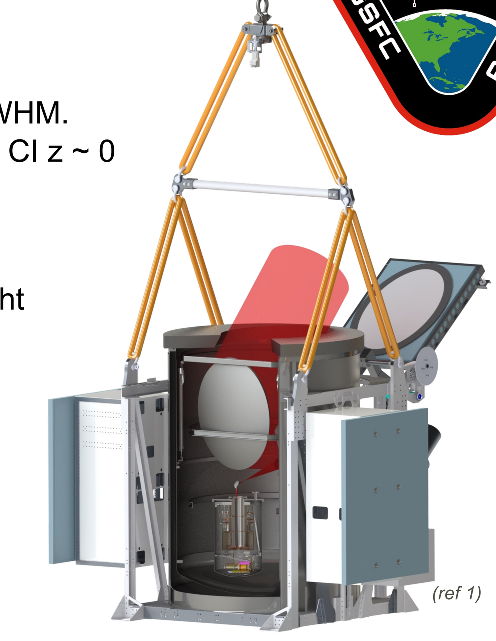
1 EXCLAIM MISSION

The **EXperiment for Cryogenic Large-Aperture Intensity Mapping (EXCLAIM)** is a balloon borne far-infrared astronomy mission that uses line intensity mapping to target extragalactic measurements of the CO rotational emission ladder at redshifts z < 1 and CII emission at redshifts z = 2.5−3.5. EXCLAIM will additionally map [CI] in the Milky Way to probe the commonly assumed CO/H_2 ratio.

Survey size: ~300 deg^2 area (wide)
Scan: ~7° in azimuth at fixed elevation 45°
Beam size: 76 cm projected aperture =~4' FWHM.
Redshifts: CO 0 < z < 0.6+, CII 2.5 < z < 3.5, CI z ~ 0
Cross correlation: BOSS quasars
Spectrometer: MKID on-chip u-Spec
Detectors: Antenna-coupled MKID
Flight duration: conventional (e.g. 1-day) flight
Flight location: NM, USA
Cryogenics: 3500 l LHe Bucket dewar
Balloon class: ~2400 kg dry mass, 34 MCF
Holding time: ~2000 l LHe fill gives 18 hr of 1.7K operation at float
Cold optics: superfluid fountain-effect pumps cool the optics to 1.7 K (Kogut+ 2021)
Heritage: ARCADE/PIPER

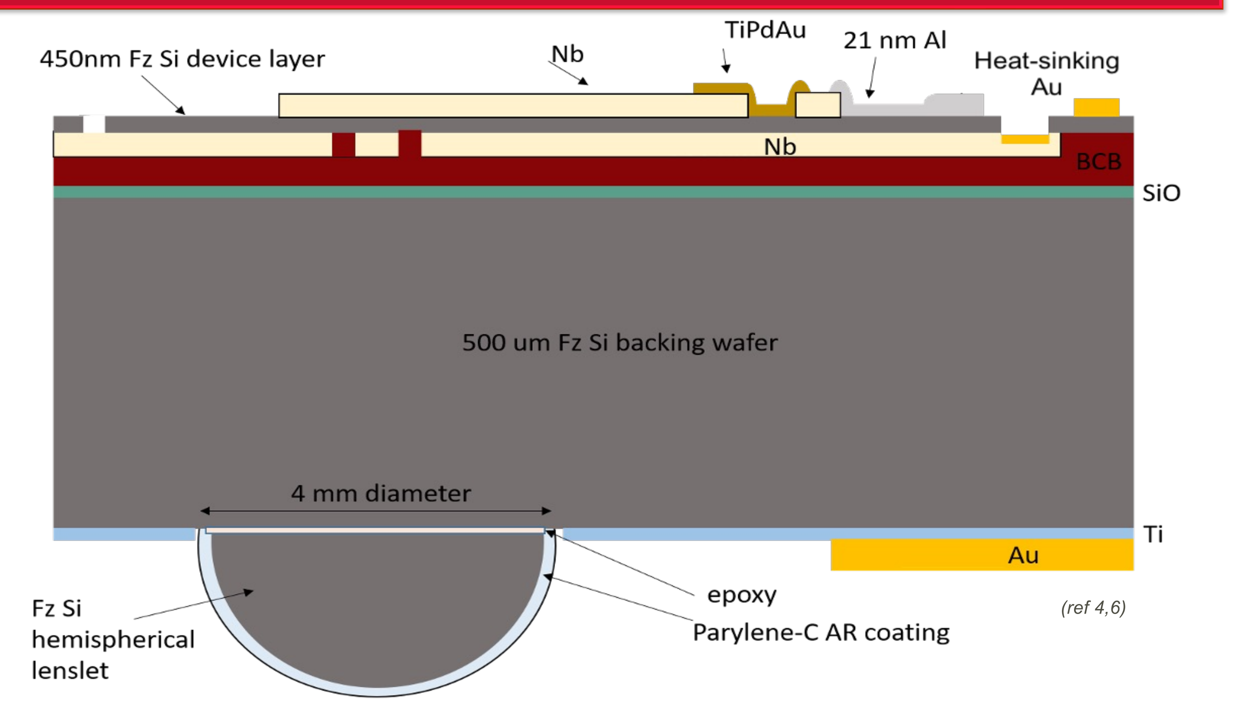


(ref 1)

ABSTRACT

The current state of far-infrared astronomy drives the need to develop compact, sensitive spectrometers for future space and ground-based instruments. Here we present details of the μ-Spec spectrometers currently in development for the far-infrared balloon mission EXCLAIM. The spectrometers are designed to cover the 555 – 714 μm range with a resolution of R = λ/Δλ = 512 at the 638 μm band center. The spectrometer design incorporates a Rowland grating spectrometer implemented in a parallel plate waveguide on a low-loss single-crystal Si chip, employing Nb microstrip planar transmission lines and thin-film Al kinetic inductance detectors (KIDs). The EXCLAIM μ-Spec design is an advancement upon a successful R = 64 μ-Spec prototype, and can be considered a sub-mm superconducting photonic integrated circuit (PIC) that combines spectral dispersion and detection. The design operates in a single M = 2 grating order, allowing one spectrometer to cover the full EXCLAIM band without requiring a multi-order focal plane. The EXCLAIM instrument will fly six spectrometers, which are fabricated on a single 150 mm diameter Si wafer. Fabrication involves a flip- wafer-bonding process with patterning of the superconducting layers on both sides of the Si dielectric. The spectrometers are designed to operate at 100 mK, and will include 355 Al KID detectors targeting a goal of NEP ~ 8×10^{-19} W/√Hz. We summarize the design, fabrication, and ongoing development of these μ-Spec spectrometers for EXCLAIM.

3 FABRICATION



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- A **bonded-wafer flip process** is used to enable the spectrometer circuit to be **fabricated on both sides** of a single crystal silicon dielectric. The single crystal silicon dielectric layers provides fundamentally **high transmission line efficiency**, and high performance MKIDs. Care is also taken throughout the process to **control** the superconducting and **dielectric interfaces** to prevent the introduction of additional loss and noise.
- The Nb liftoff and Al wet etch processes allow for the patterning of these superconducting layer **without roughening** or etching into the single crystal silicon layer. These patterning process also allow for linewidths dimensions to be precisely controlled within design tolerances.
- The film quality and resistivity parameters of the metal layers are also monitored to ensure compliance with design tolerances.
- **Sub-micron patterning** steps are required for the slot antenna design and achieved using a Heidelberg laser write tool.

2 SPECTROMETER OVERVIEW

Number of spectrometers	6
Spectrometer spectral band	555–714 μm (420–540 GHz)
Spectrometer grating order, M	2 (single order)
Spectrometer resolving power, R	512 at 472 GHz (center frequency) 535 to 505 over spectral band
Spectrometer efficiency	24%
KID NEP (at input to each KID)	8×10^{-19} W/$\sqrt{\text{Hz}}$ at 0.16 fW (at KID) at 5 to 26 Hz acoustic frequency
Number of receivers/KIDs per spectrometer	355
KID readout band	3.25 to 3.75 GHz
Operating temperature	100 mK

Above: Some key information about EXCLAIM's spectrometers.[1]

Right: The main contributing components to the overall efficiency of the EXCLAIM spectrometers and their individual efficiencies estimated from design.[2]

The slot antenna coupling and the Rowland receiver array coupling (part e. in center spectrometer figure) have the largest impact on the spectrometers' efficiency. Coupling to antennas in the Rowland region dominates overall losses.

Efficiency Contributions	Design Estimate
Slot Antenna Coupling	53 ± 5.5%
Order-Choosing Filter Transmission	≥ 98.7%
Reference coupler	96.84%
Rowland Circle Receiver Coupling	~ 50%
MKID Coupling	> 99%
Transmission Line Loss	≳ 94%
Total Efficiency Estimate	**≳ 24%**

After light travels through the telescope's cold optics, it is focused onto a focal plane that contains six 4 mm-diameter hyper-hemispherical silicon lenslets, each attached to the back of a spectrometer chip. → The light incident on the lenslet is then coupled into each spectrometer layer on the opposite side of the wafer through an x-slot antenna, where an impedance transformer then modifies the signal to match the impedance of the spectrometer's Nb microstrip transmission lines, which are of microstrip design. → The light then travels through an order-selecting filter that selects the M=2 order, and travels into a network of Nb transmission lines of varying meandered lengths that impose an approximately linear phase gradient across the array with corrections for dispersion. → The light then is sent to an array of Nb microstrip feed structure emitters, and emitted into a 2D interference region consisting of parallel-plate waveguide formed by the top and ground plane Nb superconducting layers and the single-crystal Si dielectric. → Across the 2D region, the light interferes constructively and destructively with itself as a product of the phase delay, analogous to the operation of a classic free-space spectrometer grating. → The light is then coupled into an array of microstrip feed receiver structures on the far side of the interference region, and travels through transmission lines to a corresponding array of KIDs.

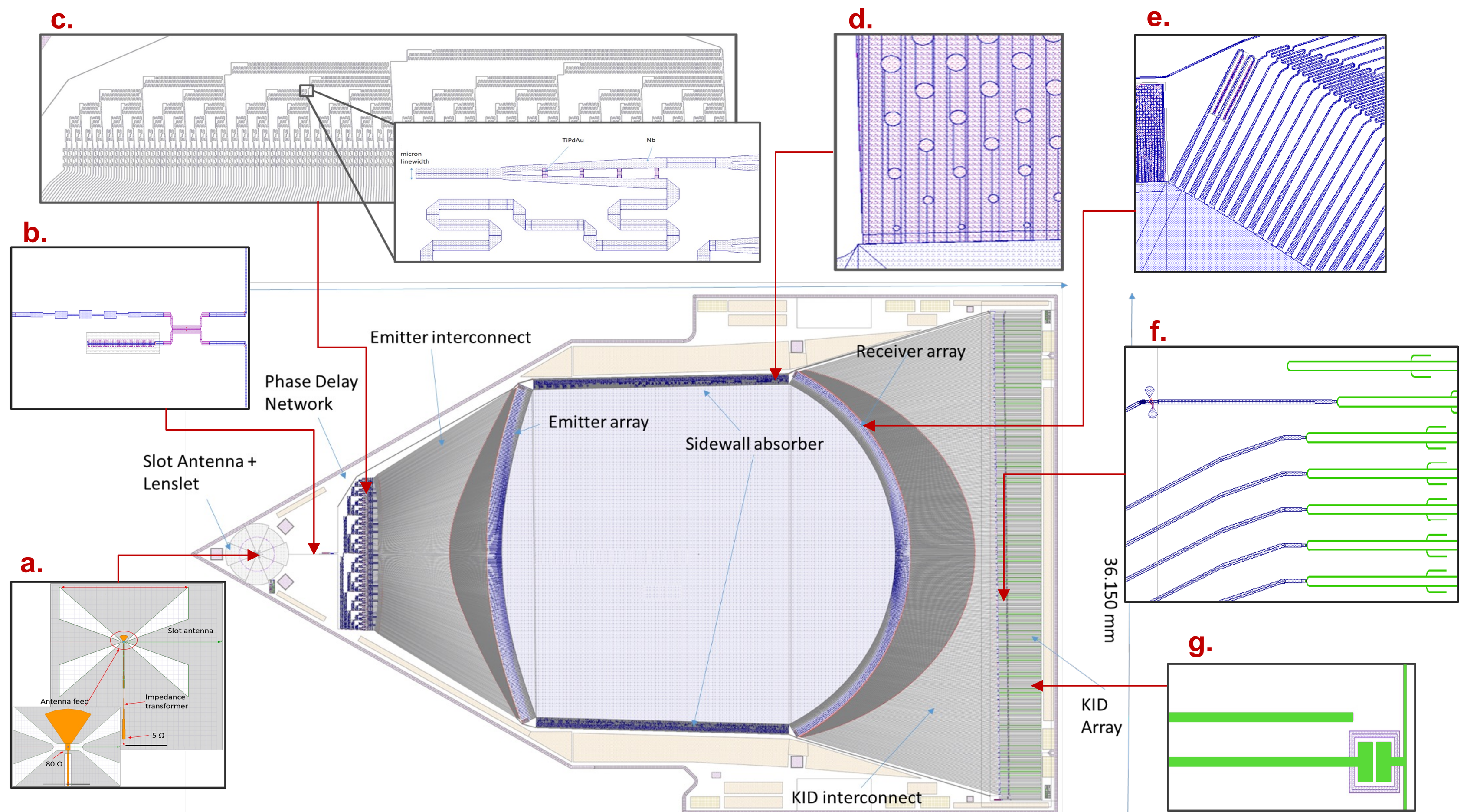

Figure: A schematic of an EXCLAIM spectrometer with detailed cutouts of individual components[2]:

a) The spectrometer's x-slot antenna depicted with the impedance transformer and a secondary transformer shown towards the bottom of the image. On the bottom left is a cutout showing a closeup of the antenna feed.

b) An order-choosing filter between the antenna and the phase-delay network that selects the order M=2. On the right the main feedline is coupled to a reference KIDs, which measures total power.

c) The spectrometer's phase-delay network. A cutout shows a closeup example of some of the meandered Nb transmission lines, which vary in path length.

d) A close-up of the sidewall of the 2D interference region, designed to terminate the portion of light that is reflected by the receiver array and input radiation that is outside of the EXCLAIM band.

e) A closeup of the top portion of the receiver array. The receiver horns feed into Nb transmission lines that connect to the spectrometer detector array.

f) The Nb lines from the receiver array connect to an array of thin-film Al microstrip KIDs. Detectors designed to diagnose noise and stray light, such as those uncoupled from the rest of the spectrometer ('dark' detectors) and those whose path skips the interference region, are included at the edges of the KID array.

g) The KIDs in the array are all coupled via parallel-plate capacitors to the readout transmission line.

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4 STRAY LIGHT

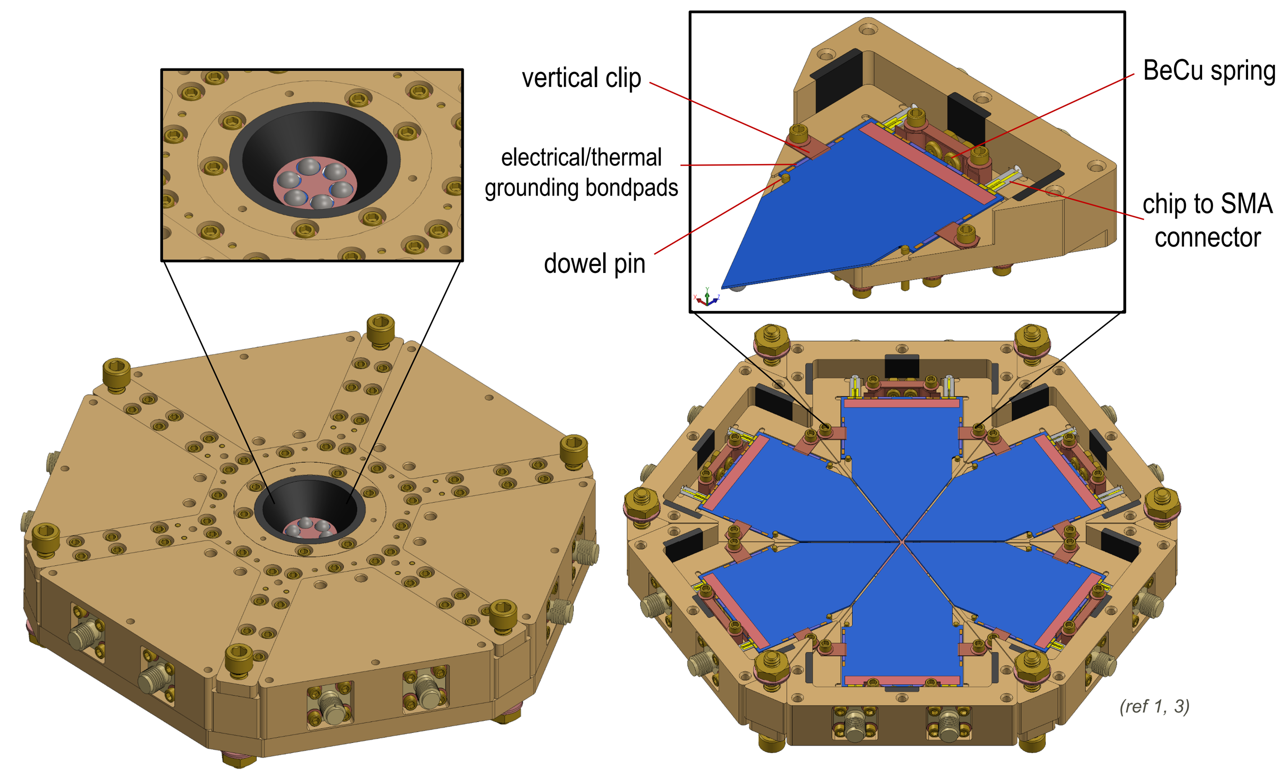
Based on results from the R=64 μ-Spec prototype, special design attention has been placed on mitigating the effects of stray light in the EXCLAIM spectrometers.

Changes include:

- The addition of **a thin Ti coating layer** with a thickness designed to target a sheet resistance **optimized to terminate stray light** in the Si backing wafer.
- The addition of a layer of **normal-metal Au** solely under the portion of the spectrometer housing the KIDs, to act as a **trap for cosmic-ray excited phonons**.
- An RF design that **minimizes ground plane cuts**.
- Al **feedlines** for readout that **absorb thermal radiation > 90 GHz**.
- And others in the **table below:**

Individual Stray Light/Cross Talk Terms	Maximum Expected Value, Equivalent In-band Power at MKID Input [aW]	Mitigation Features in Current Baseline Design
In-band Higher-Order Diffraction	0	Focal Plane Design; Sidewall absorber
In-band Diffraction Reflected	200 (non uniform distribution*)	Sidewall absorber
Out-of-band Diffraction	68 (non uniform distributions*)	Optical filters on & off chip; Nb gap; Baffle Structures/Receiver Optics Design, Sidewall absorber
In-band Optical Chain Thermal Emission Diffraction	48	Baffle Structures/Receiver Optics Design;
In-band Optical Cross-Talk Due to Spectral Function	0	Focal Plane Design
Spectrometer Backing Wafer	0.7	Optical filters off chip; Baffle Structures/Receiver Optics Design, Backside Ti coating
Spectrometer Top Package	0	Optical filters off chip; Baffle Structures/Receiver Optics ; Package blackening
Thermal On-Chip RF Line	60	Thermal blocking filters, RF chain configuration
RF cross-talk – Physical coupling	0	Microstrip architecture and thin Si dielectric (only 450 nm) , resonator frequency spacing
RF cross-talk -- Lorentzian coupling	20	High Internal Qi, Readout system accuracy
Total Budget Estimate	**378**	

5 PACKAGE



(ref 1, 3)

Principles of Package Design:

- All six on-chip μ-Spectrometers **fit without touching** in one superstructure.
- The lenslets of the individual spectrometers are **aligned** in the focal plane **when cold**.
- The spring and clip design secure the spectrometers and **allow for thermal contraction** when cold.
- Individual spectrometers can be **easily interchanged** if certain design elements are retained, **minimizing re-packaging steps** and allowing future devices to also use the same package.
- Heat sinking occurs through a copper bus to an ADR, and is maintained at **100 mK**.
- Blackening epoxy is applied where possible to **mitigate stray light** and reflections.
- Each spectrometer has two **SMA connections** for readout.

STATUS

✓ The EXCLAIM six-spectrometer superstructure **package design is complete**.

✓ The **design phase** for EXCLAIM's **spectrometers** is **complete**, and the first spectrometers are expected to be **yielded** in **early fall of 2022** to begin to undergo characterization testing.

✓ EXCLAIM plans to take its **first <24 hr flight** from NASA's Ft. Sumner, New Mexico facility in **Fall 2023**.

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This material is based upon work supported by NASA under award number 80GSFC21M0002.